

Product Specification

PE42422

UltraCMOS[®] SPDT RF Switch 5–6000 MHz

Features

- Symmetric SPDT reflective switch
- Low insertion loss
 - 0.23 dB typical @ 100 MHz
 - 0.25 dB typical @ 1000 MHz
 - 0.40 dB typical @ 3000 MHz
 - 0.65 dB typical @ 5000 MHz
 - 0.90 dB typical @ 6000 MHz
- Wide supply range of 2.3–5.5V
- Excellent linearity
 - IIP2 of 105 dBm @ 17 MHz
 - IIP3 of 81 dBm @ 17 MHz
- High ESD tolerance
 - 4 kV HBM on RF pins to GND
 - 1 kV on all other pins
- Logic Select (LS) pin provides maximum flexibility of control logic
- 12-lead 2 × 2 mm QFN package

Product Description

The PE42422 is a HaRP[™] technology-enhanced SPDT RF switch designed to cover a broad range of applications from 5–6000 MHz. This reflective switch integrates on-board CMOS control logic with a low voltage CMOS-compatible control interface and requires no external components.

Peregrine's HaRP technology enhancements deliver high linearity and exceptional harmonics performance. It is an innovative feature of the UltraCMOS[®] process, providing performance superior to GaAs with the economy and integration of conventional CMOS.

Figure 1. Functional Diagram

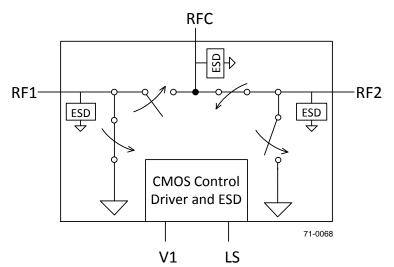


Figure 2. Package Type

12-lead 2 x 2 x 0.55 mm QFN





Table 1. Electrical Specifications @ +25 °C¹, V_{DD} = 2.3–5.5V (Z_S = Z_L = 50 Ω), unless otherwise specified

Parameter	Path	Condition	Min	Тур	Max	Unit
Operational frequency			5		6000	MHz
		5–100 MHz		0.23		dB
		100–1000 MHz		0.25	0.35	dB
		1000–2000 MHz		0.30	0.40	dB
Insertion loss ²	RFX-RFC	2000–3000 MHz		0.40	0.50	dB
		3000–4000 MHz		0.50	0.70	dB
		4000–5000 MHz		0.65	0.90 ²	dB
		5000–6000 MHz		0.90	1.25 ²	dB
		5–100 MHz		68		dB
		100–1000 MHz	42	44		dB
		1000–2000 MHz	33	35		dB
Isolation	RFX-RFC	2000–3000 MHz	27	29		dB
		3000–4000 MHz	22	24		dB
		4000–5000 MHz	18	20		dB
		5000–6000 MHz	15	17		dB
	RFX-RFX	5–100 MHz		61		dB
		100–1000 MHz	40	41		dB
		1000–2000 MHz	32	33		dB
Isolation		2000–3000 MHz	26	28		dB
		3000–4000 MHz	22	24		dB
		4000–5000 MHz	18	20		dB
		5000–6000 MHz	15	16		dB
		5–100 MHz		33		dB
		100-1000 MHz		28		dB
	RFX-RFC	1000–2000 MHz		21		dB
Return loss ²		2000–3000 MHz		20		dB
		3000–4000 MHz		18		dB
		4000–5000 MHz		16 ²		dB
		5000–6000 MHz		13 ²		dB
		+18 dBm input power, 17–204 MHz		-92		dBc
2nd harmonic	RFX-RFC	+32 dBm output power, 850 / 900 MHz		-99		dBc
		+32 dBm output power, 1800 / 1900 MHz		-101		dBc
	RFX-RFC	+18 dBm input power, 17–204 MHz		-125		dBc
3rd harmonic		+32 dBm output power, 850 / 900 MHz		-93		dBc
		+32 dBm output power, 1800 / 1900 MHz		-87		dBc
IMD3	RF-RFC	Bands I, II, V, VIII +17 dBm CW @ TX freq at RFC, -15 dBm CW @ 2Tx-Rx at RFC, 50Ω		-115		dBm



Table 1. Electrical Specifications @ +25 °C¹, V_{DD} = 2.3–5.5V (Z_s = Z_L = 50 Ω), unless otherwise specified

Parameter	Path	Condition	Min	Тур	Max	Unit
IIP2	RFX	5 MHz 17 MHz 100–6000 MHz		96 105 115		dBm dBm dBm
IIP3	RFX	5 MHz 17 MHz 100–6000 MHz		75 81 75		dBm dBm dBm
Input 0.1dB compression point ³	RFX or RFC	5–100 MHz 100–6000 MHz		33 34		dBm dBm
Switching time		50% CTRL to (10%–90%) or (90%–10%) RF		2	4	μs

Notes:

Typical performance over temperature and V_{DD} shown in *Figure 5* through *Figure 21*.
High frequency performance can be improved by external matching (see *Figure 22* through *Figure 27 and Figure 30*).
The input P0.1dB compression point is a linearity figure of merit. Refer to *Table 4* for the operating RF input power.



Figure 3. Pin Configuration (Top View)

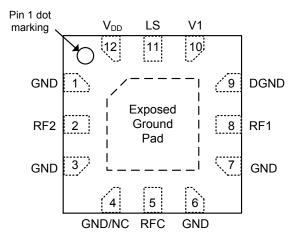


Table 2. Pin Descriptions

Pin No.	Pin Name	Description
1	GND	Ground
2	RF2 ¹	RF port 2
3	GND	Ground
4	GND/NC ²	Ground or no connect
5	RFC ¹	RF common
6	GND	Ground
7	GND	Ground
8	RF1 ¹	RF port 1
9	DGND	Digital Ground
10	V1	Switch control input, CMOS logic level
11	LS	Logic Select, CMOS logic level
12	V _{DD}	Supply
Pad	GND	Exposed pad: ground for proper operation

1. RF pins 2, 5 and 8 must be at 0 VDC. The RF pins do not required DC Notes: blocking capacitors for proper operation if the 0 VDC requirement is met. 2. Pin 4 can be grounded or left unconnected externally.

Table 3. Truth Table

Path	V1	LS
RFC-RF2	1	1
RFC-RF1	0	1
RFC-RF1	1	0
RFC-RF2	0	0

Table 4. Operating Ranges

Parameter	Min	Тур	Max	Unit
V _{DD} Supply voltage	2.3	3.3	5.5	V
IDD Power supply current		120	200	μA
RFX–RFC input power			Fig. 4	dBm
Control voltage high	1.2	1.5	3.3	V
Control voltage low	0	0	0.5	V
Operating temperature range	-40	+25	+85	°C

Table 5. Absolute Maximum Ratings

Parameter/Condition	Min	Max	Unit
RF input power, 50Ω ¹ 5–100 MHz 100–6000 MHz		33 34	dBm dBm
ESD voltage HBM ² RF pins to GND All other pins		4000 1000	V V
ESD voltage MM, all pins ³		200	V
T _{ST} Storage temperature	-65	+150	°C

1. V_{DD} within operating range specified in Table 4. Notes:

Human Body Model (MIL_STD 883 Method 3015.7).
Machine Model (JEDEC JESD22-A115-A).

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table.

Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS devices are immune to latch-up.

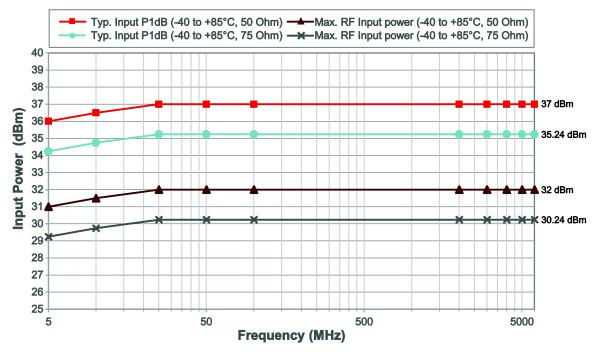
Moisture Sensitivity Level

The Moisture Sensitivity Level rating for the PE42422 in the 12-lead 2 × 2 × 0.55 mm QFN package is MSL1.





Figure 4. Power De-rating Curve for 5–6000 MHz





Typical Performance Data @ +25 °C and V_{DD} = 3.3V, unless otherwise specified Figure 5. Insertion Loss RFX*

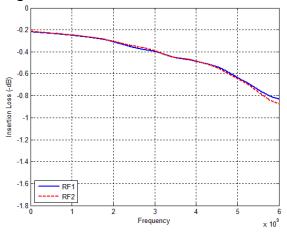


Figure 6. Insertion Loss vs Temp (RF1-RFC)*

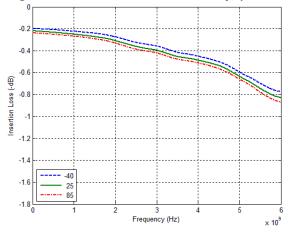
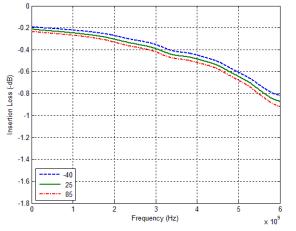


Figure 7. Insertion Loss vs Temp (RF2-RFC)*



Note: * High frequency performance can be improved by external matching (see Figure 22 through Figure 27 and Figure 30).

©2012-2016 Peregrine Semiconductor Corp. All rights reserved.

Figure 8. Insertion Loss vs V_{DD} (RF1–RFC)*

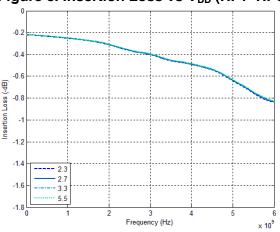
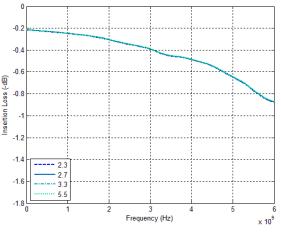


Figure 9. Insertion Loss vs V_{DD} (RF2–RFC)*



Document No. DOC-33314-4 | UltraCMOS® RFIC Solutions



Typical Performance Data @ +25 °C and V_{DD} = 3.3V, unless otherwise specified (cont.)Figure 10. RFX-RFX Isolation vs TempFigure 12. RFX-RFX Isolation vs V_{DD}

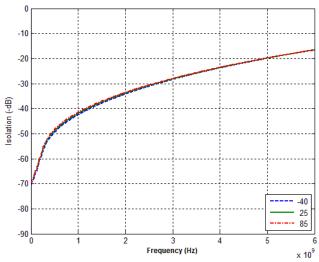
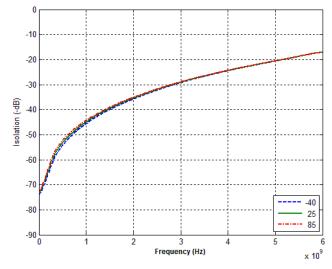
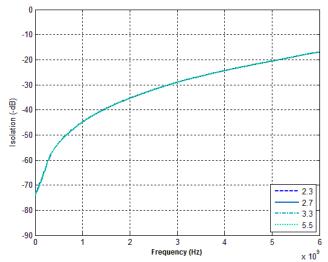


Figure 11. RFC–RFX Isolation vs Temp

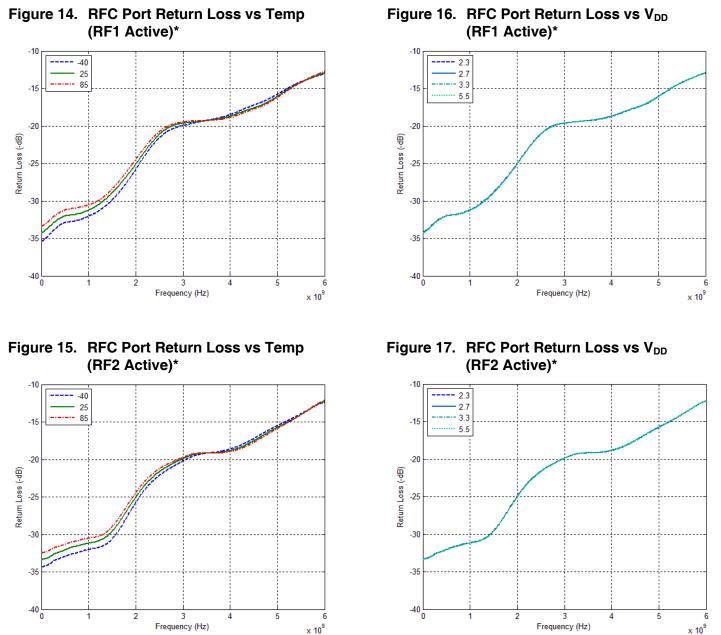


0 -10 -20 -30 Isolation (-dB) -40 -50 -60 -70 2.3 27 -80 33 5.5 -90 L 0 3 Frequency (Hz) 2 4 5 6 x 10^s

Figure 13. RFC–RFX Isolation vs V_{DD}





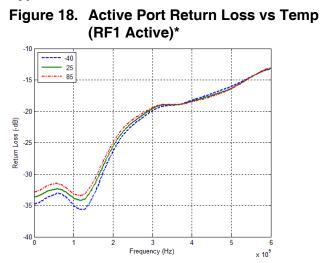


Typical Performance Data @ +25 °C and V_{DD} = 3.3V, unless otherwise specified (cont.)

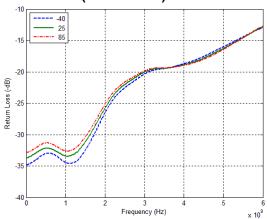
Note: * High frequency performance can be improved by external matching (see Figure 22 through Figure 27 and Figure 30).

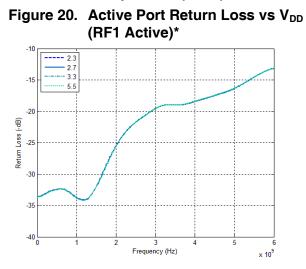


Typical Performance Data @ +25 °C and V_{DD} = 3.3V, unless otherwise specified (cont.)

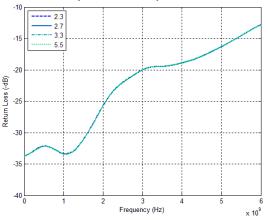












Note: * High frequency performance can be improved by external matching (see Figure 22 through Figure 27 and Figure 30).



Performance Comparison @ +25 °C and V_{DD} = 3.3V, with or without matching

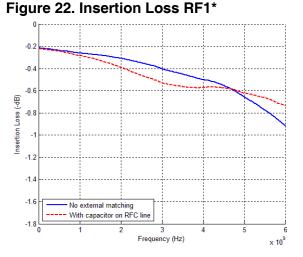


Figure 23. Active Port Return Loss (RF1 Active)*

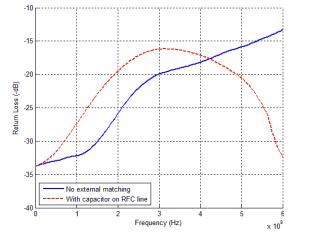
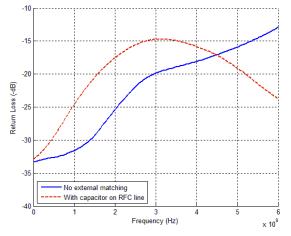
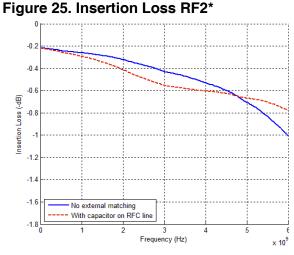


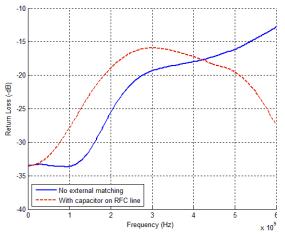
Figure 24. RFC Port Return Loss (RF1 Active)*



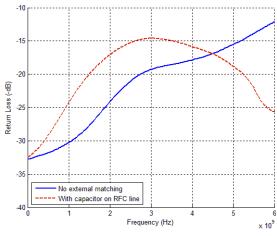
Note: * High frequency performance can be improved by external matching (see Figure 22 through Figure 27 and Figure 30).











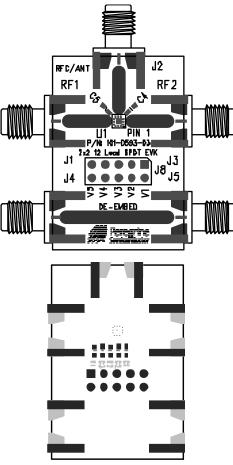


Evaluation Board

The SPDT switch evaluation board was designed to ease customer evaluation of Peregrine's PE42422. The RF common port is connected through a 50 Ω transmission line via the top SMA connector, J2. RF1 and RF2 ports are connected through 50 Ω transmission lines via SMA connectors J1 and J3, respectively. A through 50 Ω transmission is available via SMA connectors J4 and J5. This transmission line can be used to estimate the loss of the PCB over the environmental conditions being evaluated. J8 provides DC and digital inputs to the device.

The board is constructed of a four metal layer material with a total thickness of 62 mils. The top and bottom RF layers are Rogers RO4350 material with a 10 mil RF core. The middle layers provide ground for the transmission lines. The transmission lines were designed using a coplanar waveguide with ground plane model using a trace width of 22 mils, trace gaps of 7 mils, and metal thickness of 2.1 mils.

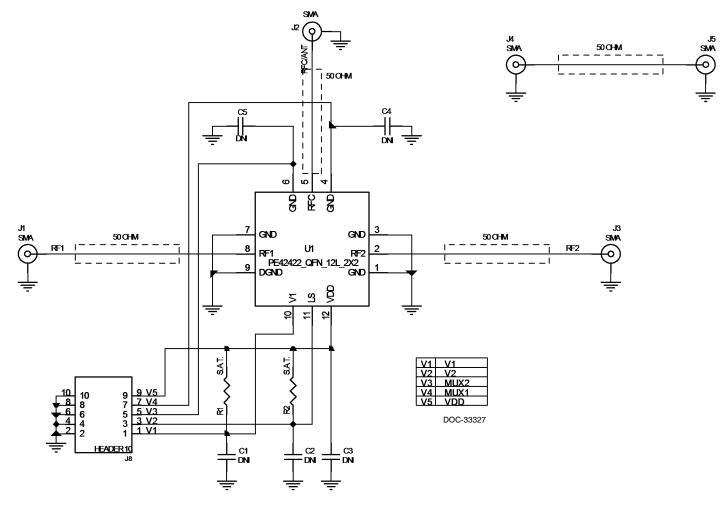
Figure 28. Evaluation Board Layout



PRT-29005



Figure 29. Evaluation Board Schematic







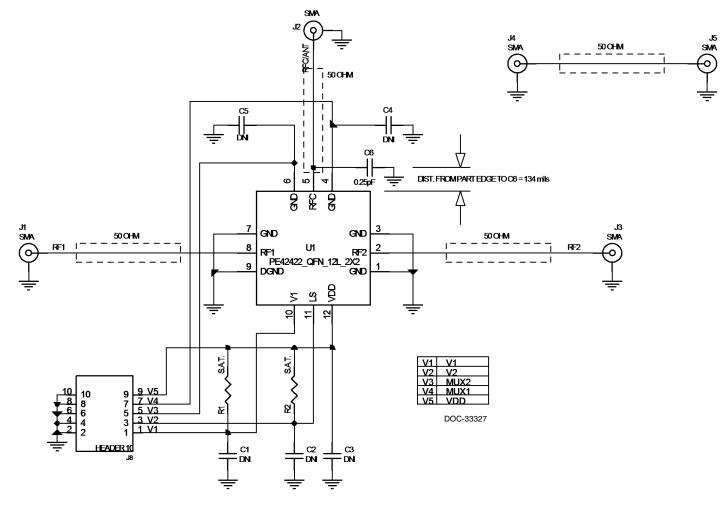




Figure 31. Package Drawing 12-lead 2 × 2 × 0.55 mm QFN

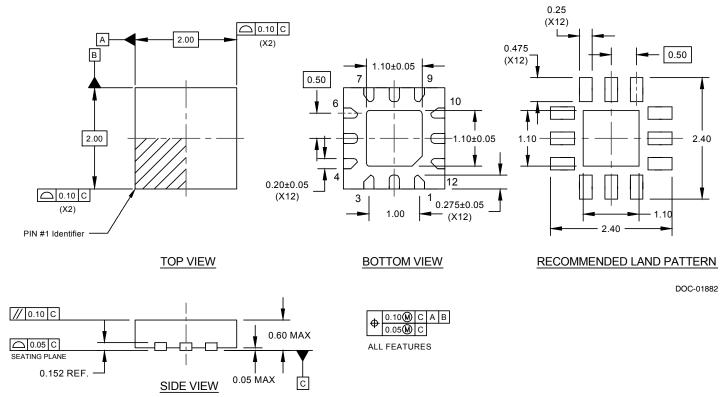




Figure 32. Top Marking Specifications



Marking Spec Symbol	Package Marking	Definition	
РР	DE	Part number marking for PE42422	
ZZ	00-99	Last two digits of lot code	
Y 0-9		Last digit of year, starting from 2009 (0 for 2010, 1 for 2011, etc)	
WW 01-53		Work week	



DOC-66046

Marking Spec Symbol	Package Marking	Definition
PP	DE	Part number marking for PE42422
ZZ	00-99	Last two digits of lot code
YY	YY 00-99 Last two digits of assembly year (Ex: 15 for 2015)	
ww	01-53	Work week



Figure 33. Tape and Reel Specifications

12-lead $2 \times 2 \times 0.55$ mm QFN

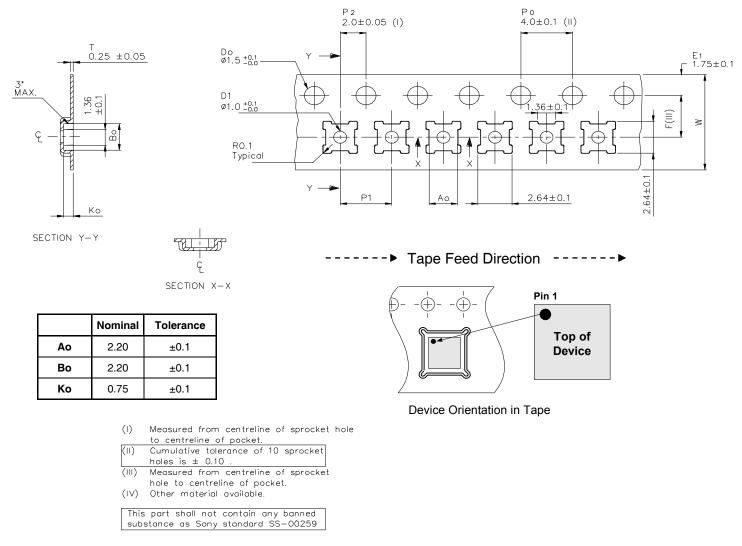


Table 6. Ordering Information

Order Code	Description	Package	Shipping Method
PE42422MLAA-Z	PE42422 SPDT RF switch	Green 12-lead 2 × 2mm QFN	3000 units T/R
EK42422-01	PE42422 Evaluation board	Evaluation kit	1/Box

Sales Contact and Information

For sales and contact information please visit www.psemi.com.

<u>Advance Information</u>: The product is in a formative or design stage. The datasheet contains design target specifications for product development. Specifications and features may change in any manner without notice. <u>Preliminary Specification</u>: The datasheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product. <u>Preduct Specification</u>: The datasheet contains final data. In the event Peregrine decides to change the specifications, Peregrine will notify customers of the intended changes by issuing a CNF (Customer Notification Form).

The information in this datasheet is believed to be reliable. However, Peregrine assumes no liability for the use of this information. Use shall be entirely at the user's own risk.

©2012-2016 Peregrine Semiconductor Corp. All rights reserved.

No patent rights or licenses to any circuits described in this datasheet are implied or granted to any third party. Peregrine's products are not designed or intended for use in devices or systems intended for surgical implant, or in other applications intended to support or sustain life, or in any application in which the failure of the Peregrine product could create a situation in which personal injury or death might occur. Peregrine assumes no liability for damages, including consequential or incidental damages, arising out of the use of its products in such applications.

The Peregrine name, logo, UltraCMOS and UTSi are registered trademarks and HaRP, MultiSwitch and DuNE are trademarks of Peregrine Semiconductor Corp. Peregrine products are protected under one or more of the following U.S. Patents: <u>http://patents.psemi.com</u>.

Document No. DOC-33314-4 | UltraCMOS® RFIC Solutions

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Development Tools category:

Click to view products by pSemi manufacturer:

Other Similar products are found below :

MAAM-011117 MAAP-015036-DIEEV2 EV1HMC1113LP5 EV1HMC6146BLC5A EV1HMC637ALP5 EVAL-ADG919EBZ ADL5363-EVALZ LMV228SDEVAL SKYA21001-EVB SMP1331-085-EVB EV1HMC618ALP3 EVAL01-HMC1041LC4 MAAL-011111-000SMB MAAM-009633-001SMB MASW-000936-001SMB 107712-HMC369LP3 107780-HMC322ALP4 SP000416870 EV1HMC470ALP3 EV1HMC520ALC4 EV1HMC244AG16 EV1HMC539ALP3 EV1HMC6789BLC5A MAX2614EVKIT# 124694-HMC742ALP5 SC20ASATEA-8GB-STD MAX2837EVKIT+ MAX2612EVKIT# MAX2692EVKIT# EV1HMC629ALP4E SKY12343-364LF-EVB 108703-HMC452QS16G EV1HMC863ALC4 EV1HMC427ALP3E 119197-HMC658LP2 EV1HMC647ALP6 ADL5725-EVALZ MAX2371EVKIT# 106815-HMC441LM1 EV1HMC1018ALP4 UXN14M9PE MAX2016EVKIT EV1HMC939ALP4 MAX2410EVKIT MAX2204EVKIT+ EV1HMC8073LP3D SIMSA868-DKL SIMSA868C-DKL SKY65806-636EK1 SKY68020-11EK1